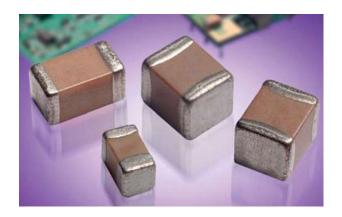
### **General Specifications**



X7R formulations are called "temperature stable" ceramics and fall into EIA Class II materials. X7R is the most popular of these intermediate dielectric constant materials. Its temperature variation of capacitance is within  $\pm 15\%$  from -55°C to +125°C. This capacitance change is non-linear.

Capacitance for X7R varies under the influence of electrical operating conditions such as voltage and frequency.

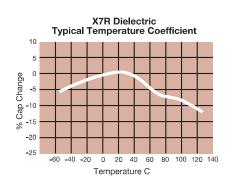
X7R dielectric chip usage covers the broad spectrum of industrial applications where known changes in capacitance due to applied voltages are acceptable.

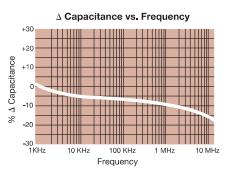


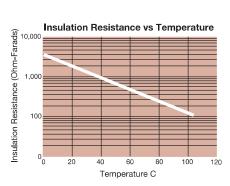
#### PART NUMBER (see page 2 for complete part number explanation)

0805	<u>5</u>	<u>C</u>	<u>103</u>	<u>M</u>	A	<b>T</b>	<u>2</u>	<b>A</b>
Size (L" x W")	<b>Voltage</b> 4V = 4 6.3V = 6 10V = Z 16V = Y	<b>Dielectric</b> X7R = C	Capacitance Code (In pF) 2 Sig, Digits + Num- ber of Zeros	Capacitance Tolerance J = ± 5%* K = ±10% M = ± 20%	Failure Rate A = Not Applicable	Terminations T = Plated Ni and Sn Z= FLEXITERM®**	Packaging 2 = 7" Reel 4 = 13" Reel	Special Code A = Std. Product
	25V = 3 50V = 5 100V = 1 200V = 2			*≤1µF only, contact factory for addi- tional values		*Optional termination	Contact Factory For Multiples	
	500V = 7					**See FLEXITERM® X7R section		

NOTE: Contact factory for availability of Termination and Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.



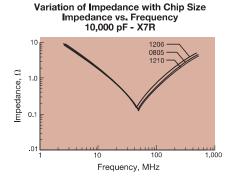


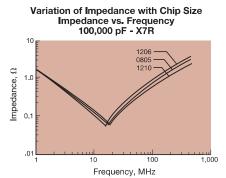


Impedance vs. Frequency
1,000 pF vs. 10,000 pF - X7R
0805

10.00 pF
1,000 pF

Variation of Impedance with Cap Value





## **Specifications and Test Methods**

Parame	ter/Test	X7R Specification Limits		Conditions						
Operating Tem		-55°C to +125°C	Temperature Cycle Chamber							
Capac		Within specified tolerance ≤ 10% for ≥ 50V DC rating ≤ 12.5% for 25V DC rating ≤ 12.5% for 25V and 16V DC rating ≤ 12.5% for ≤ 10V DC rating	Freq.: 1.0 kHz ± 10% Voltage: 1.0Vrms ± .2V For Cap > 10µF, 05Vrm @ 120Hz							
Insulation	Resistance	100,000MΩ or 1000MΩ - $\mu$ F, whichever is less	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity							
Dielectric	Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max)  Note: Charge device with 150% of rated voltage for 500V devices.							
	Appearance	No defects		on: 2mm						
Resistance to	Capacitance Variation	≤ ±12%	_	30 seconds 7 1mm/sec						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)								
	Insulation Resistance	≥ Initial Value x 0.3	90	mm —						
Solder	rability	≥ 95% of each terminal should be covered with fresh solder		c solder at 230 ± 5°C 0.5 seconds						
Resistance to Solder Heat	Appearance	No defects, <25% leaching of either end terminal								
	Capacitance Variation	≤ ±7.5%	Dip device in outcetic	vice in eutectic solder at 260°C for 60						
	Dissipation Factor	Meets Initial Values (As Above)	seconds. Store at room temperature for 24 ± 2 hours before measuring electrical properties.							
	Insulation Resistance	Meets Initial Values (As Above)		ig dioditical proportion.						
	Dielectric Strength	Meets Initial Values (As Above)								
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes						
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes						
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +125°C ± 2°	30 ± 3 minutes						
SHOCK	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp	≤ 3 minutes						
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 ± 2 hours at room temperature							
	Appearance	No visual defects								
	Capacitance Variation	≤ ±12.5%	Charge device with 1.5 rated voltage (≤ 10V) in test chamber set at 125°C ± 2°C for 1000 hours (+48, -0)							
Load Life	Dissipation Factor	≤ Initial Value x 2.0 (See Above)								
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	at room temperatu	hamber and stabilize ire for 24 ± 2 hours						
	Dielectric Strength	Meets Initial Values (As Above)	before measuring.							
	Appearance	No visual defects	Store in a test chamb	ner set at 85°C + 2°C/						
	Capacitance Variation	≤ ±12.5%	Store in a test chamber set at 85°C ± 2°C/ 85% ± 5% relative humidity for 1000 hours (+48, -0) with rated voltage applied.  Remove from chamber and stabilize at							
Load Humidity	Dissipation Factor	≤ Initial Value x 2.0 (See Above)								
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	room temperatur	e and humidity for						
	Dielectric Strength	Meets Initial Values (As Above)	24 ± 2 hours before measuring.							

#### **Capacitance Range**

#### PREFERRED SIZES ARE SHADED

SIZE 0101\* 0603 0201 0402 0805 1206 Soldering Reflow/Wave Reflow Only Reflow Only Reflow/Wave Reflow/Wave Reflow/Wave Paper/Embossed 2.01 ± 0.20 (0.079 ± 0.008) 1.25 ± 0.20 (0.049 ± 0.008) 0.50 ± 0.25 All Paper 0.60 ± 0.03 (0.024 ± 0.001) 0.30 ± 0.03 All Paper 1.00 ± 0.10 (0.040 ± 0.004) 0.50 ± 0.10 All Paper 1.60 ± 0.15 (0.063 ± 0.006) 0.81 ± 0.15 Paper/Embossed 3.20 ± 0.20 (0.126 ± 0.008) 1.60 ± 0.20 Packaging Paper/Embossed 0.40 ± 0.02 (0.016 ± 0.0008) 0.20 ± 0.02 (0.008 ± 0.0008) 0.10± 0.04 (L) Length (W) Width (0.063 ± 0.008) 0.50 ± 0.25 (0.011 ± 0.001) 0.15 ± 0.05 (0.020 ± 0.004) 0.25 ± 0.15 (0.032 ± 0.006) 0.35 ± 0.15 (in. (t) Terminal (0.010 ± 0.006) 6.3 10 16 25 50 (0.020 ± 0.010) 6.3 | 10 | 16 | 25 | 50 | 100 | 200 (0.020 ± 0.010) 16 | 25 | 50 | 100 | 200  $(0.004 \pm 0.0016)$ 681 102 152 222 332 472 682 103 153 0.01 0.015 0.022 0.033 0.047 0.068 6 25 50 100 200 63 10 16 25 50 100 200 63 10 16 0603 50 100 200 500 10 16 **0402** 1206 SIZE 0101 0201

Letter	A	B	C	E	G	J	K	M	N	P	Q	X	Y	_ Z		
Max.	0.33	0.22	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.80	2.29	2.54	2.79		
Thickness	(0.013)	(0.009)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.071)	(0.090)	(0.100)	(0.110)		
			PAF	PER			EMBOSSED									

PAPER and EMBOSSED available for 01005

NOTE: Contact factory for non-specified capacitance values

\*EIA 01005

\*\*Contact Factory for Specifications

## **Capacitance Range**

#### PREFERRED SIZES ARE SHADED

TILLI EKKED SIZES AKE SHADED																									
SIZI					1210				4942							4005				2000	2005				
					1812					1825			2220					-	2225						
	Oldering Reflow Only						Reflow Only							eflow O			Reflow Only					eflow O			
Packag		Paper/Embossed								All Em		d		All	4.50 ± 0.3		All Embossed						Embos: 5,72 ± 0,2		
(L) Length	mm (in.)	3.30 ± 0.4 (0.130± 0.016)					4.50 ± 0.30 (0.177 ± 0.012)					((	4.50 ± 0.3 0.177 ± 0.0	5.70 ± 0.40 (0.225 ± 0.016)						(0.225 ± 0.010)					
(W) Width	mm	2.50 ± 0.20						3.20 ± 0.20						$6.40 \pm 0.4$	0	5.00 ± 0.40					6.35 ± 0.25		25		
(**) **idui	(in.)	(0.098 ± 0.008)								(0.126 :					$0.252 \pm 0.0$			(0.197 ± 0.016)					$0.250 \pm 0.0$		
(t) Terminal	mm (in.)				0.50 ± 0.1 .020 ± 0.1						0.61 :					0.61 ± 0.3 0.024 ± 0.0				0.64 ± 0.3 .025 ± 0.0				0.64 ± 0.3 0.025 ± 0.0	
	WVDC	10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200
Cap 100	101																				١.		<del>  _</del>		
(pF) 150	151	_																			<u> </u>	$\sim$	$\stackrel{\frown}{}$	₩>	_
220 330	221 331	_	1			-														~				1) 🚹	T
470	471	$\vdash$	1	<del>                                     </del>	<u> </u>	+			_				1						<del>                                     </del>		( )	) )		レセ	_
680	681		<u> </u>										<b>†</b>									4			
1000	102																					4			
1500	152	J	J	J	J	J	J	M														1			
2200	222	J	J	J	J	J	J	M M					1							-	-	-	1	<u> </u>	—
3300 4700	332 472	J J	J	J	J	J	J	M					1		_	-							+	-	<del></del>
6800	682	J	J	J	J	J	J	M					1										1	$\vdash$	$\vdash$
Cap 0.01	103	J	J	J	J	J	J	M		K	K	K	K	K	M	M	M		Х	Х	Х	Х	M	Р	Р
(µF) 0.015	153	J	J	J	J	J	J	Р		K	K	K	K	Р	M	M	M		Х	Х	Χ	Х	M	Р	Р
0.022	223	J	J	J	J	J	J	Q		K	K	K	K	Р	M	M	M		Х	Х	Х	Х	М	Р	P
0.033	333 473	J J	J	J	J	J	J	Q		K K	K	K	K	Z	M M	M	M		X	X	X	X	M M	P P	P P
0.047	683	J.	J	J	J	J	M	Q		K	K	K	K	Z	M	M	M		X	X	X	X	M	P	P
0.1	104	J	J	J	J	Ĵ	M	X		K	K	K	K	Z	M	M	M		Х	X	X	X	M	P	P
0.15	154	J	J	J	J	M	Z	Z		K	K	K	Р	Z	M	M	M		Х	Х	Х	Х	М	Р	Х
0.22	224	J	J	J	J	Р	Z			K	K	K	Р	Z	M	M	M		Х	Х	Х	Х	М	Р	Х
0.33	334 474	J M	J M	J M	J	Q				K	K	M	X	Z	M M	M M			X	X	X	X	M M	P P	X
0.68	684	M	M	P	X	X	Z		_	M	M	Q		L	M	P			X	X	^	^	M	P	X
1.0	105	N	N	P	X	Z	_			M	M	X	Z		M	P			Х	X	Х	Z	M	P	X
1.5	155	N	N	Z	Z	Z				Z	Z	Z			Q	Х			Х	Х			М	Х	Z
2.2	225	Х	Х	Z	Z	Z				Z	Z	Z			Х	Х	Z		Х	Х			М	X	Z
3.3	335	X	X	Z	Z	Z 7				Z	Z	Z				-			X	Z			Z	Х	Z
4.7	475 106	Z	Z	Z	Z			<del>                                     </del>	Z	Z	Z	Z			Z	Z			Z	Z			Z	Z	<u> </u>
22	226	Z	Z	Z				<del>                                     </del>					+					Z					Z		<del></del>
47	476	Z	_																						
100	107																								
	WVDC	10	16	25	50	100	200	500	16	25	50	100	200	500	50	100	200	25	50	100	200	500	50	100	200
SIZE				1210						18	12				1825		2220						2225		
	Δ.		D					0			17									V I			-	_	
Letter Max.	0.33		B 0.22	0.		0.71	-	G 0.90	J K M					N P			Q X Y 1.80 2.29 2.54				4	Z 2.79	-		
Thickness	(0.013)		0.22	(0.0		(0.028	3) (	0.90		.94 037)	(0.040		(0.050)		40 055)	(0.060		0.071)		.29 090)	(0.10		(0.110)		
HICKHESS	(0.013)	(	,,,,,,	1 (0.0	-/	,	<i>'</i> )   (	0.000)	(0.0	551)	(0.040	·/   \	(0.000)	(0.0	300)	٠,	,	,	1 (0.	000)	(0.10	,0,	(0.110)	-	
l		PAPER EMBOSSED																							

NOTE: Contact factory for non-specified capacitance values